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Atty. Docket No. 05823.0112

To the Assistant Co

100764485

Please record the attached original documents or copy thereof.

ATTN. BOX ASSIGNMENTS

1. Name of conveying party(ies):

Kil-Yeong CHOI

Mi-Hie YI

Moon-Young JIN

Dae-Woo IHM

Jae-Min OH

Additional names(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: KOREA RESEARCH INSTITUTE OF
CHEMICAL TECHNOLOGY

Internal Address: _____

Street Address: 100, Jang-dong,
Yusung-ku, Daejeon 305-343, Republic of
Korea

City: _____

State: _____ ZIP: _____

Additional name(s) & address(es) attached?
☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____Execution Date: July 2, 1998

4. Application number(s) or patent number(s):

If this document is being filed together with a new application,
the execution date of the application is: _____

A. Patent Application Nos.

09/086,385

B. Patent No.(s)

Additional numbers attached? ☐ YES ☒ NO5. Name and address of party to whom
correspondence concerning document
should be mailed:Name: Mr. Ernest F. Chapman

Internal Address: _____

Finnegan, Henderson, Farabow, Garrett
& Dunner, L.L.P.

Street Address: _____

1300 I Street, N.W.City: Washington, D.C.State: _____ ZIP: 200056. Total number of applications and patents
involved 17. Total fee (37 CFR 3.41): \$ 40.00☒ Enclosed☐ Authorized to be charged to
deposit account8. Deposit account number: 06-0916

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40.00 UP

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct
and any attached copy is a true copy of the original document.Dennis P. O'Reilley

Name of Person Signing

Signature

July 10, 1998

Date

Total number of pages including cover sheet, attachments and document: 3

PATENT

REEL: 9301 FRAME: 0226

A S S I G N M E N T

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

SOLUBLE POLYIMIDE RESIN FOR LIQUID CRYSTAL ALIGNMENT LAYER AND PROCESS OF PREPARATION OF THE SAME

for which I/WE executed an application for United States Letters Patent concurrently herewith or on _____ or filed an application for United States Letters Patent on May 29, 19 98 (Serial No. 09/086,385); and

WHEREAS, KOREA RESEARCH INSTITUTE OF CHEMICAL TECHNOLOGY, a corporation of Republic of Korea, whose post office address is 100, Jang-dong, Yusung-ku, Daejeon 305-343, Republic of Korea (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with assignee, its successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful paper when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. 09/086,385, filed May 29, 1998) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/We have hereunto set our hand(s).

1. Full Name of Sole or First Assignor : Assignor's Signature	:	Date
Kil-Yeong CHOI	:	July 2, 1998
Address 101-904, Hyundai Apt., 431-6, Doryong-dong, Yusung-ku,	:	Citizenship
Daejeon 305-340, Republic of Korea	:	Korean
2. Full Name of Second Assignor : Assignor's Signature	:	Date
Mi-Hie YI	:	July 2, 1998
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Daejeon 305-390, Republic of Korea	:	Korean
3. Full Name of Third Assignor : Assignor's Signature	:	Date
Moon-Young JIN	:	July 2, 1998
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305-390, Republic of Korea	:	Korean

FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P. - WASHINGTON, D.C.

4. Full Name of Fourth Assignor	: Assignor's Signature	: Date
Dae-Woo IHM	: <i>D. W. Ihm</i>	: July 2, 1998
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5. Full Name of Fifth Assignor	: Assignor's Signature	: Date
Jae-Min OH	: <i>[Signature]</i>	: July 2, 1998
Address 102-1202, Samho-Baikjo Apt., 358-3, Ojeon-dong, Euiwang-si 437-070, Republic of Korea		: Citizenship : Korean
6. Full Name of Sixth Assignor	: Assignor's Signature	: Date
Address		: Citizenship
7. Full Name of Seventh Assignor	: Assignor's Signature	: Date
Address		: Citizenship
8. Full Name of Eighth Assignor	: Assignor's Signature	: Date
Address		: Citizenship
9. Full Name of Ninth Assignor	: Assignor's Signature	: Date
Address		: Citizenship
10. Full Name of Tenth Assignor	: Assignor's Signature	: Date
Address		: Citizenship
11. Full Name of Eleventh Assignor	: Assignor's Signature	: Date
Address		: Citizenship
12. Full Name of Twelfth Assignor	: Assignor's Signature	: Date
Address		: Citizenship